

Title (en)
ADHESIVE FORMULATIONS

Title (de)
KLEBSTOFF-FORMULIERUNGEN

Title (fr)
FORMULATIONS D'ADHÉSIF

Publication
EP 2877507 A1 20150603 (DE)

Application
EP 13739730 A 20130724

Priority

- EP 12178178 A 20120727
- EP 2013065571 W 20130724
- EP 13739730 A 20130724

Abstract (en)
[origin: WO2014016325A1] The present invention relates to adhesive formulations based on polyaddition compounds, which polyaddition compounds have uretdione groups and are free of isocyanate groups and monomeric polyisocyanates, and to the use thereof in producing adhesive connections between substrates, in particular in producing flexible film composites.

IPC 8 full level
C08G 18/02 (2006.01); **C08G 18/79** (2006.01); **C08G 18/80** (2006.01); **C09J 175/04** (2006.01)

CPC (source: EP US)
B32B 7/12 (2013.01 - US); **B32B 15/085** (2013.01 - US); **B32B 15/20** (2013.01 - US); **B32B 37/12** (2013.01 - US); **B32B 37/18** (2013.01 - US);
B32B 37/182 (2013.01 - US); **C08G 18/027** (2013.01 - EP US); **C08G 18/798** (2013.01 - EP US); **C08G 18/80** (2013.01 - EP US);
C08G 18/8016 (2013.01 - EP US); **C08G 18/8064** (2013.01 - EP US); **C09J 175/04** (2013.01 - EP US); **B32B 2255/06** (2013.01 - US);
B32B 2255/26 (2013.01 - US); **B32B 2553/00** (2013.01 - US); **Y10T 428/31587** (2015.04 - EP US)

Citation (search report)
See references of WO 2014016325A1

Designated contracting state (EPC)
AL AT BE BG CH CY CZ DE DK EE ES FI FR GB GR HR HU IE IS IT LI LT LU LV MC MK MT NL NO PL PT RO RS SE SI SK SM TR

Designated extension state (EPC)
BA ME

DOCDB simple family (publication)
WO 2014016325 A1 20140130; CA 2879922 A1 20140130; EP 2877507 A1 20150603; US 2015175859 A1 20150625; US 9657206 B2 20170523

DOCDB simple family (application)
EP 2013065571 W 20130724; CA 2879922 A 20130724; EP 13739730 A 20130724; US 201314416739 A 20130724